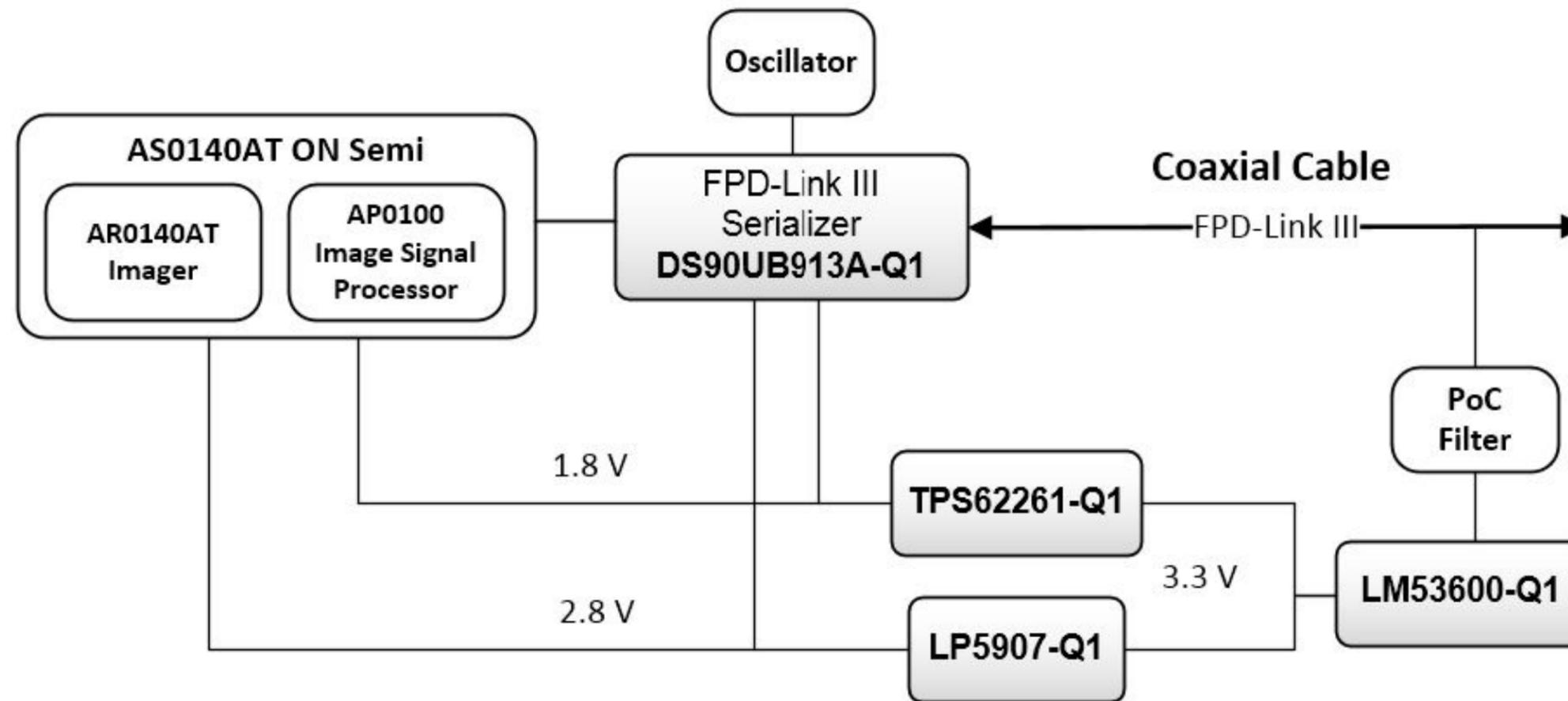


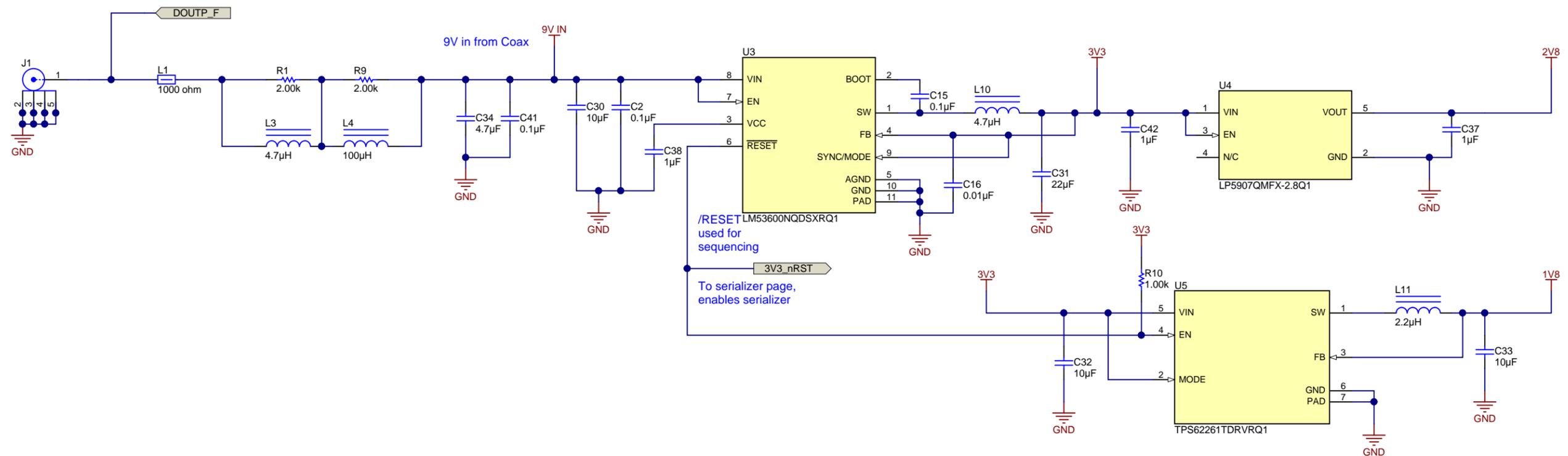
Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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TID #: N/A	Project Title: TIDA-01003-EVM	Sheet: 1 of 5	
Number: TIDA-01003	Rev: E4	Size: B	
SVN Rev: Version control disabled	Assembly Variant: 001	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	
Drawn By:	File: TIDA-01003_CoverSheet_SchDoc		
Engineer: L. CORDOVA			

## Power over Coax Filter & Power Supply



**/RESET**  
used for  
sequencing

**3V3 nRST**  
To serializer page,  
enables serializer

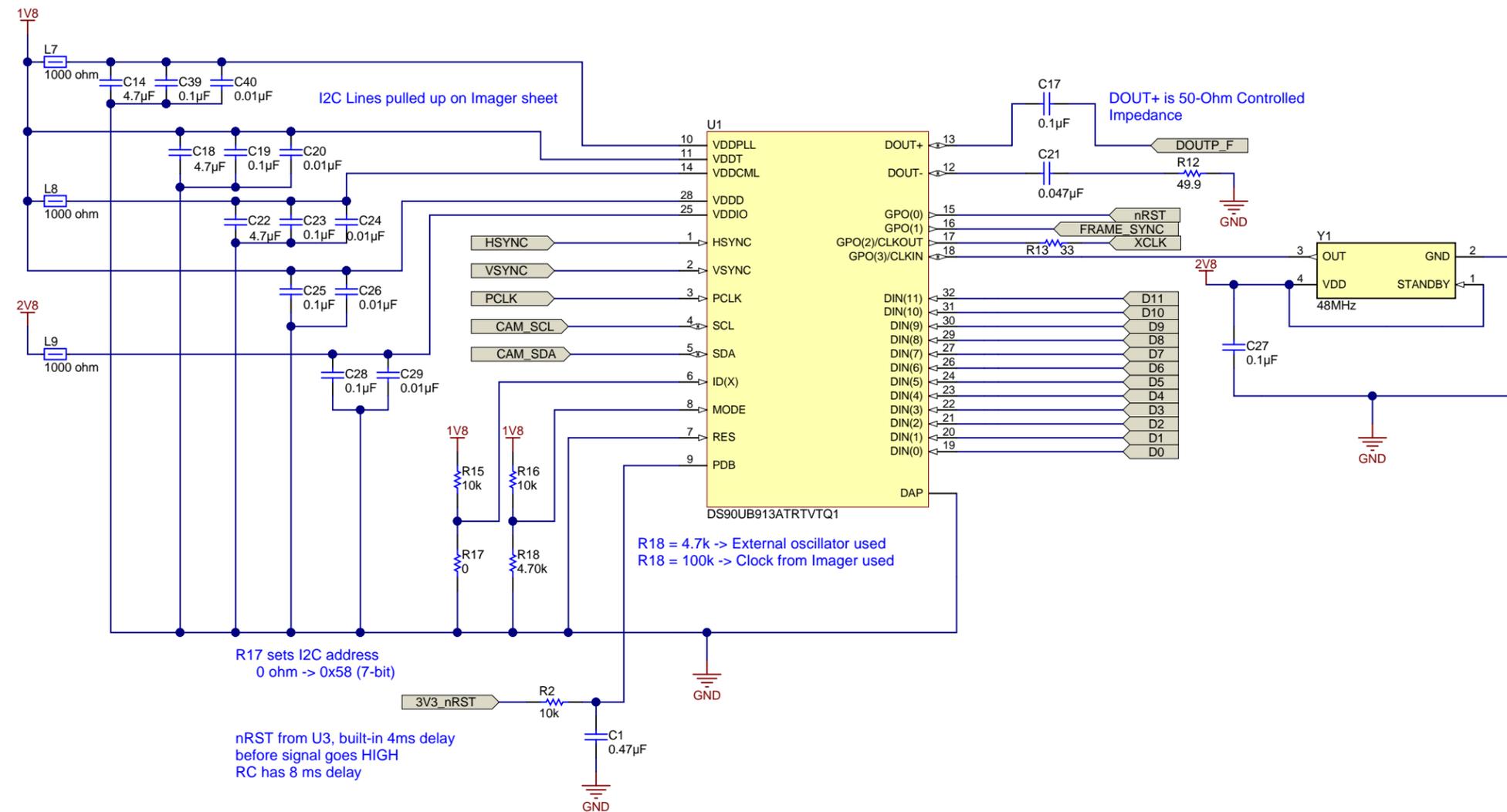
Orderable: <a href="#">ChangeMe!</a>	Designed for: Not Public Release	Mod. Date: 1/11/2018
TID #: N/A	Project Title: TIDA-01003-EVM	
Number: TIDA-01003	Rev: E4	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 5
Drawn By:	File: Wide Vin Power Supply and PoC Filter.SchDoc	Size: B
Engineer: L. CORDOVA	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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# Serializer

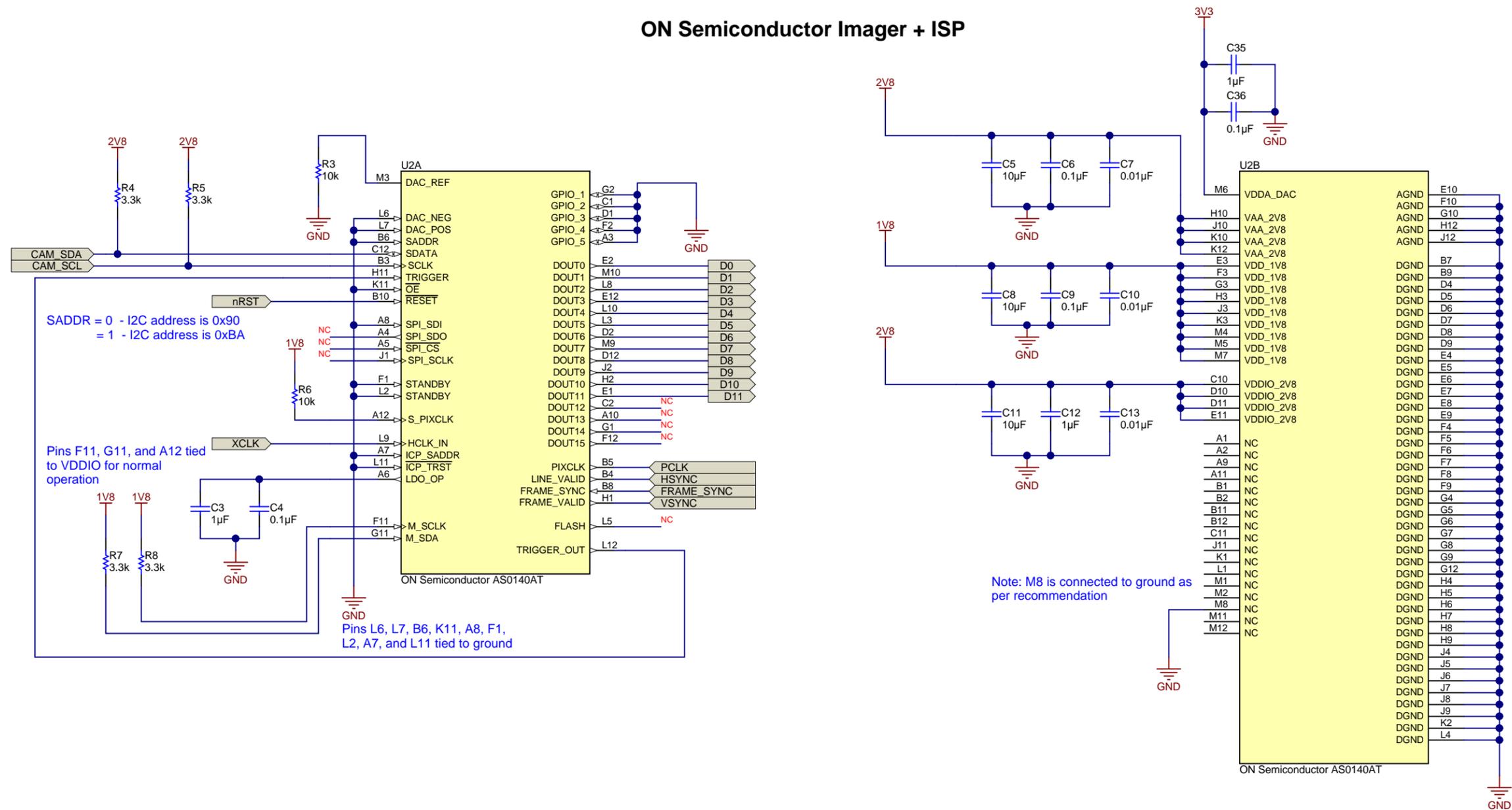


Orderable: <a href="#">ChangeMe!</a>	Designed for: Not Public Release	Mod. Date: 3/30/2017
TID #: N/A	Project Title: TIDA-01003-EVM	
Number: TIDA-01003	Rev: E4	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 5
Drawn By:	File: <a href="#">Wide Vin Serializer.SchDoc</a>	Size: B
Engineer: L. CORDOVA	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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## ON Semiconductor Imager + ISP



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Orderable: <a href="#">ChangeMe!</a>	Designed for: Not Public Release	Mod. Date: 1/17/2018
TID #: N/A	Project Title: TIDA-01003-EVM	
Number: TIDA-01003	Rev: E4	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 4 of 5
Drawn By:	File: Wide_Vin_ON_Semi_Imager_Processor.SchDoc	Size: B
Engineer: L. CORDOVA	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



PCB Number: TIDA-01003  
PCB Rev: E4

PCB LOGO  
Pb-Free Symbol

PCB LOGO  
FCC disclaimer

Variant/Label Table	
Variant	Label Text
001	TIDA-01003-EVM

LBL1  
PCB Label  
Size: 0.65" x 0.20"

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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